

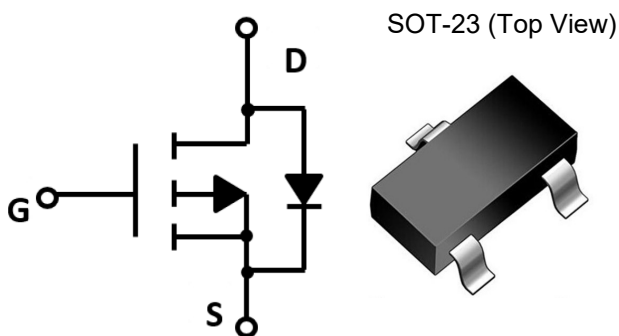
Description

CMBSS84 is the P-Channel enhancement mode power field effect transistors with high cell density, trench technology. This high density process and design have been optimized switching performance and especially tailored to minimize on-state resistance.

Features

- V_{DS} : -60V
- I_D : -0.17A
- $R_{DS(on)}$ (@ $V_{GS}=-10V$): $< 8\Omega$
- $R_{DS(on)}$ (@ $V_{GS}=-4.5V$): $< 10\Omega$
- High density cell design for extremely low $R_{DS(on)}$
- Excellent on-resistance and DC current capability

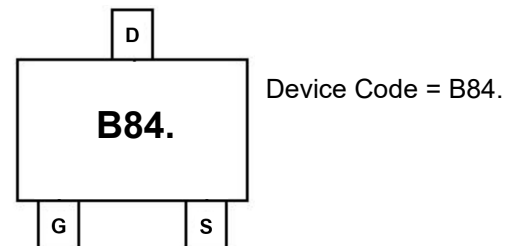
Equivalent Circuit and Pin Configuration



Applications

- Cellular Handsets and Accessories
- Personal Digital Assistants
- Portable Instrumentation
- Load switch

Marking Information



Ordering Information

Part Number	Packaging	Reel Size
CMBSS84	3000/Tape & Reel	7 inch

Absolute Maximum Ratings (TA=25 °C unless otherwise noted)

Parameter	Symbol	Maximum	Unit	
Drain-source Voltage	V_{DS}	-60	V	
Gate-source Voltage	V_{GS}	± 20	V	
Continuous Drain Current	I_D	$T_A=25^\circ C$	-0.17	A
		$T_A=70^\circ C$	-0.14	A
Pulsed Drain Current ⁽¹⁾	I_{DM}	-0.68	A	
Total Power Dissipation @ $T_A=25^\circ C$ ⁽²⁾	P_D	225	mW	
Thermal Resistance Junction-to-Ambient ⁽²⁾	$R_{\theta JA}$	556	$^\circ C/W$	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to +150	$^\circ C$	

Electrical Characteristics (T_J=25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250μA	-60			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-60V, V _{GS} =0V, T _C =25°C			-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.9		-2.0	V
Static Drain-Source on-Resistance	R _{DS(on)}	V _{GS} =-10V, I _D =-0.15A		3.3	8	Ω
		V _{GS} =-4.5V, I _D =-0.15A		3.5	10	
Diode Forward Voltage	V _{SD}	I _S =-0.17A, V _{GS} =0V			-1.2	V
Maximum Body-Diode Continuous Current	I _S				-17	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-30V, V _{GS} =0V, f=1MHz		30		pF
Output Capacitance	C _{oss}			10		
Reverse Transfer Capacitance	C _{rss}			5		
Switching Parameters						
Turn-on Delay Time	t _{D(on)}	V _{GS} =-4.5V, V _{DD} =-30V, I _D =-0.15A, R _{GEN} =2.5Ω		2.5		ns
Turn-on Rise Time	t _r			1		
Turn-off Delay Time	t _{D(off)}			16		
Turn-off Fall Time	t _f			8		

Noted: (1) Pulse Test: Pulse Width ≤ 300us, Duty cycle ≤ 2%.

(2) Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. With 2oz Copper, t ≤ 10s

Typical Performance Characteristics

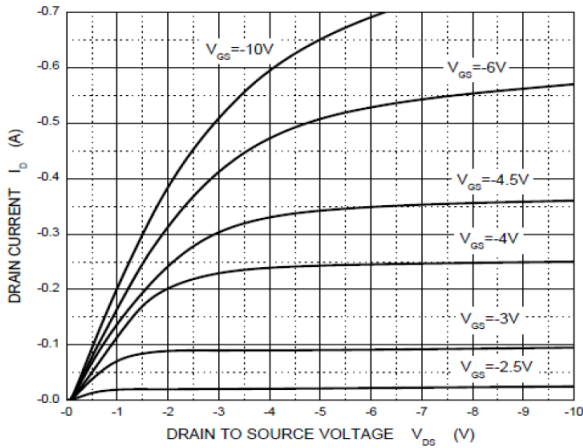


Figure 1. Output Characteristics

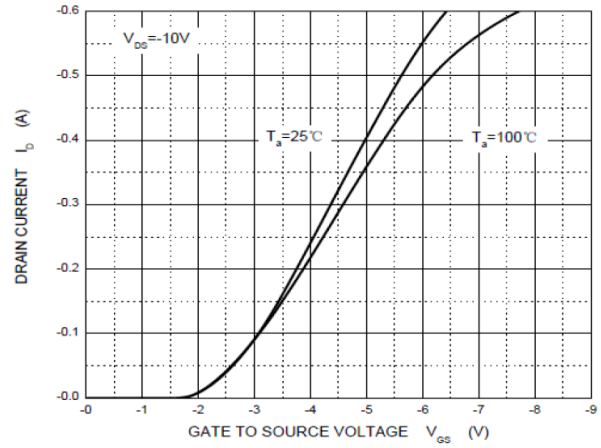


Figure 2. Transfer Characteristics

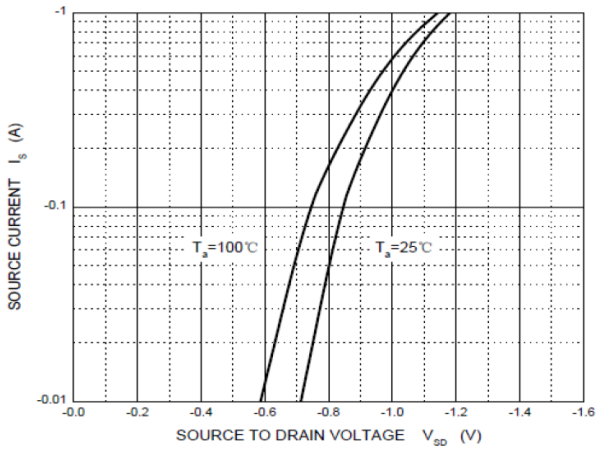


Figure 3. Diode Forward Voltage vs. current

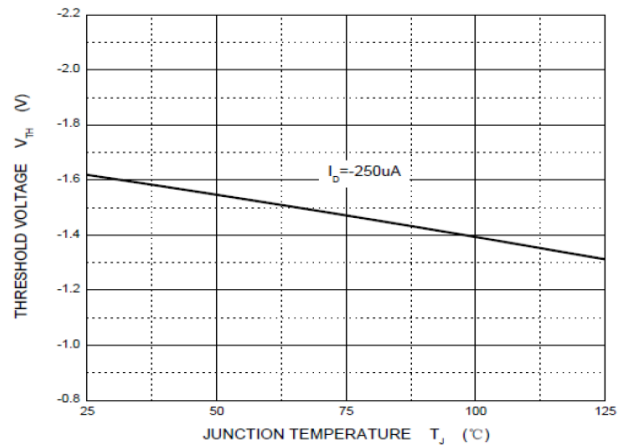


Figure 4. Gate Threshold vs. Junction Temperature

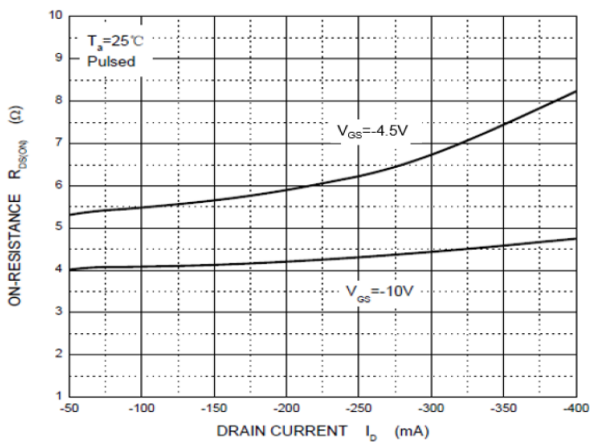


Figure 5. Drain-Source on Resistance

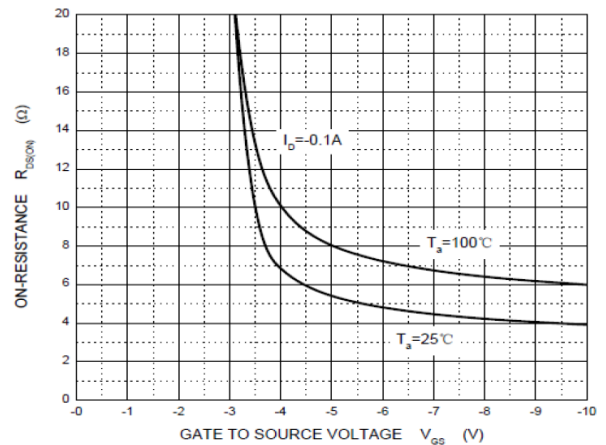


Figure 6. Drain-Source On Resistance

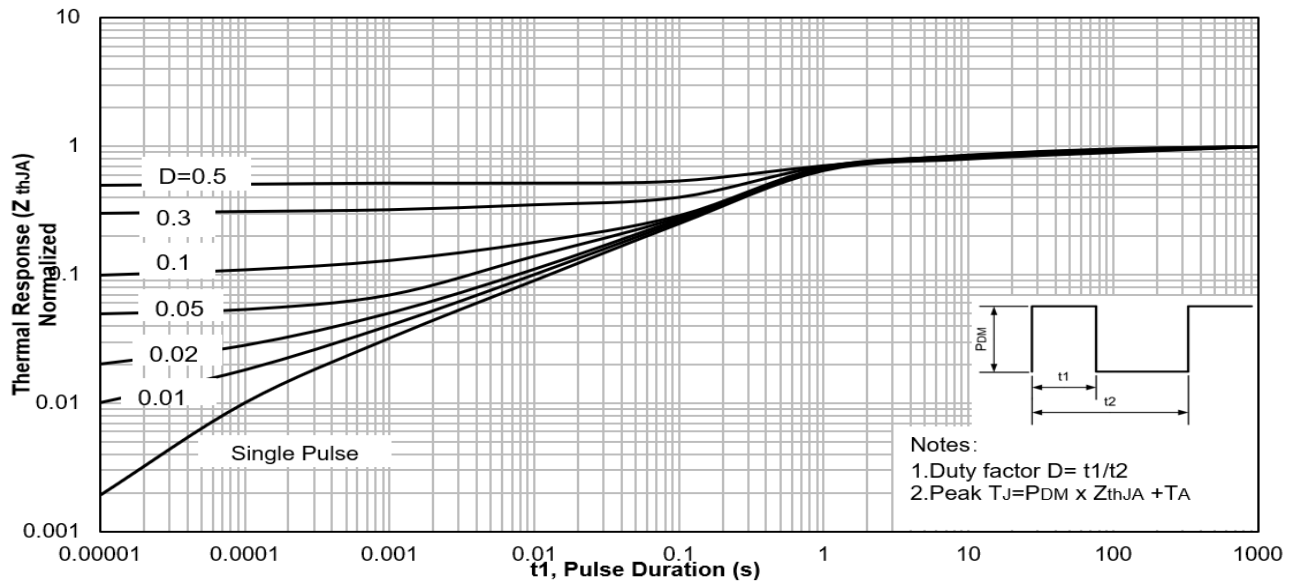


Figure 7. Maximum Effective Transient Thermal Impedance ,Junction-to-Ambient

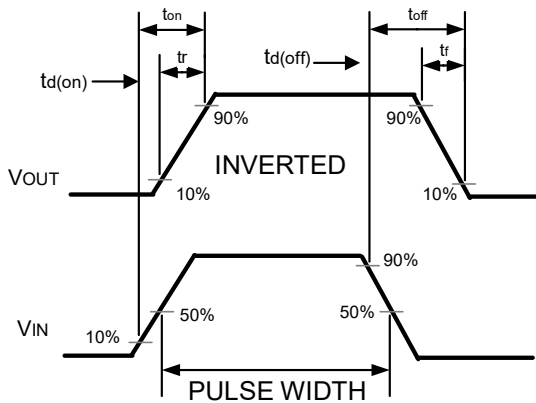
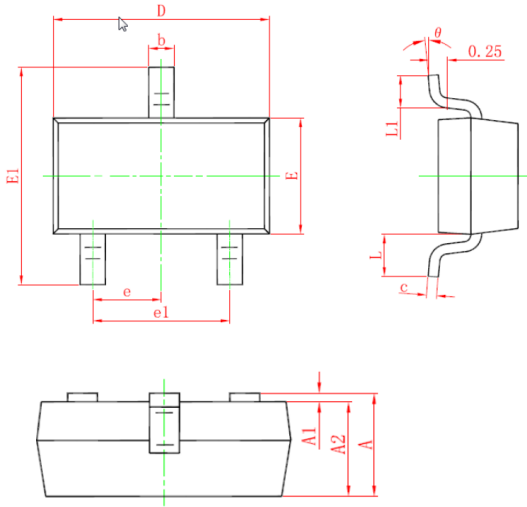


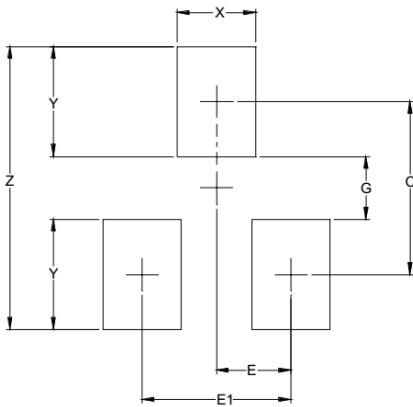
Figure 8. Switching wave

SOT-23 Package Outline Drawing

(Unit : mm)



SYM	DIMENSIONS					
	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.90	--	1.15	0.035	--	0.045
A1	0.00	--	0.10	0.000	--	0.004
A2	0.90	--	1.05	0.035	--	0.041
b	0.30	--	0.50	0.012	--	0.020
c	0.08	--	0.15	0.003	--	0.006
D	2.80	--	3.00	0.110	--	0.118
E	1.20	--	1.40	0.047	--	0.055
E1	2.25	--	2.55	0.089		0.100
e	0.95TYP			0.037TYP		
e1	1.80	--	2.00	0.071	--	0.079
L	0.55REF			0.022REF		
L1	0.30	--	0.50	0.012	--	0.020
Θ	0°	--	8°	0°	--	8°

Suggested Land Pattern


SYM	DIMENSIONS	
	INCHES	MILLIMETERS
C	0.087	2.20
E	0.037	0.95
E1	0.075	1.90
G	0.031	0.80
X	0.039	1.00
Y	0.055	1.40
Z	0.141	3.60